DNSemi

Analog Multiplexers/ Demultiplexers

High-Performance Silicon-Gate CMOS

MC74HC4051A, MC74HC4052A, MC74HC4053A

The MC74HC4051A, MC74HC4052A and MC74HC4053A utilize silicon-gate CMOS technology to achieve fast propagation delays, low ON resistances, and low OFF leakage currents. These analog multiplexers/demultiplexers control analog voltages that may vary across the complete power supply range (from V_{CC} to V_{EE}).

The HC4051A, HC4052A and HC4053A are identical in pinout to the metal-gate MC14051AB, MC14052AB and MC14053AB. The Channel-Select inputs determine which one of the Analog Inputs/Outputs is to be connected, by means of an analog switch, to the Common Output/Input. When the Enable pin is HIGH, all analog switches are turned off.

The Channel-Select and Enable inputs are compatible with standard CMOS outputs; with pullup resistors they are compatible with LSTTL outputs.

These devices have been designed so that the ON resistance (R_{on}) is more linear over input voltage than Ron of metal-gate CMOS analog switches.

For a multiplexer/demultiplexer with injection current protection, see HC4851A and HC4852A.

Features

- Fast Switching and Propagation Speeds
- Low Crosstalk Between Switches
- Diode Protection on All Inputs/Outputs
- Analog Power Supply Range $(V_{CC} V_{EE}) = 2.0$ to 12.0 V
- Digital (Control) Power Supply Range $(V_{CC} GND) = 2.0$ to 6.0 V
- Improved Linearity and Lower ON Resistance Than Metal-Gate Counterparts
- Low Noise
- In Compliance with the Requirements of JEDEC Standard No. 7A
- Chip Complexity: HC4051A 184 FETs or 46 Equivalent Gates HC4052A - 168 FETs or 42 Equivalent Gates HC4053A - 156 FETs or 39 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR-Free and are RoHS Compliant

This document contains information on some products that are still under development. onsemi reserves the right to change or discontinue these products without notice.





SOIC-16

D SUFFIX

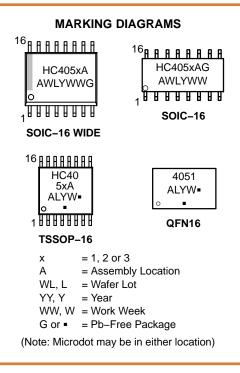
SOIC-16 WIDE **DW SUFFIX CASE 751G**

CASE 751B



TSSOP-16 DT SUFFIX CASE 948F

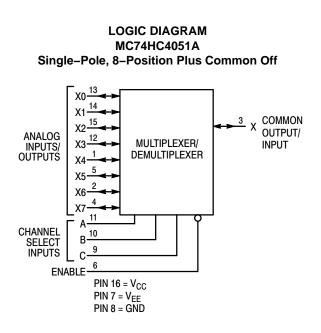
QFN16 **MN SUFFIX** CASE 485AW



ORDERING INFORMATION

See detailed ordering and shipping information on page 13 of this data sheet.

NOTE: Some of the devices on this data sheet have been DISCONTINUED. Please refer to the table on page 13.

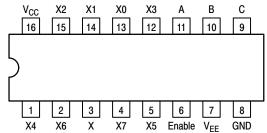


FUNCTION TABLE - MC74HC4051A

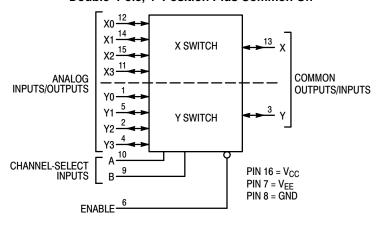
Control Inputs				
		Selec	t	
Enable	С	в	Α	ON Channels
L	L	L	L	X0
L	L	L	н	X1
L	L	Н	L	X2
L	L	Н	Н	X3
L	н	L	L	X4
L	н	L	Н	X5
L	н	Н	L	X6
L	н	Н	Н	X7
н	X	Х	Х	NONE

X = Don't Care

Pinout: MC74HC4051A (Top View)



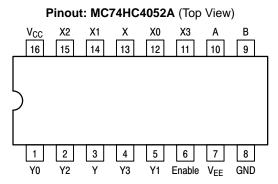
LOGIC DIAGRAM MC74HC4052A Double-Pole, 4-Position Plus Common Off

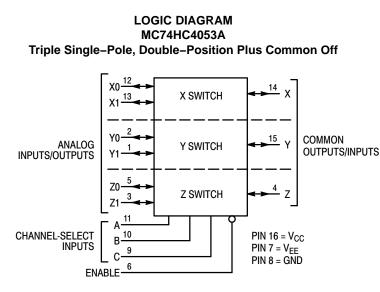


FUNCTION TABLE – MC74HC4052A

Contr	ol Input			
Enable	Select			onnolo
Enable	В	A	ON Ch	anneis
L	L	L	Y0	X0
L	L	Н	Y1	X1
L	н	L	Y2	X2
L	н	Н	Y3	X3
Н	Х	Х	NO	NE

X = Don't Care



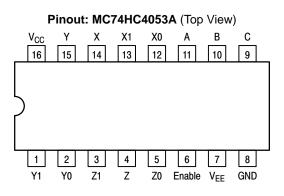


NOTE: This device allows independent control of each switch. Channel-Select Input A controls the X-Switch, Input B controls the Y-Switch and Input C controls the Z-Switch

FUNCTION TABLE – MC74HC4053A

Conti	Control Inputs					
Enable	Select C B A			ON	I Chann	els
L	L	L	L	Z0	Y0	X0
L	L	L	Н	Z0	Y0	X1
L	L	Н	L	Z0	Y1	X0
L	L	Н	Н	Z0	Y1	X1
L	н	L	L	Z1	Y0	X0
L	н	L	Н	Z1	Y0	X1
L	н	Н	L	Z1	Y1	X0
L	н	Н	Н	Z1	Y1	X1
Н	X	Х	Х		NONE	

X = Don't Care



MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Positive DC Supply Voltage (Referenced to GND) (Referenced to V _{EE})	-0.5 to +7.0 -0.5 to +14.0	V
V _{EE}	Negative DC Supply Voltage (Referenced to GND)	-7.0 to +5.0	V
V _{IS}	Analog Input Voltage	V _{EE} – 0.5 to V _{CC} + 0.5	V
V _{in}	Digital Input Voltage (Referenced to GND)	-0.5 to V _{CC} + 0.5	V
I	DC Current, Into or Out of Any Pin	±25	mA
P _D	Power Dissipation in Still Air, SOIC Package† TSSOP Package†	500 450	mW
T _{stg}	Storage Temperature Range	-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds SOIC or TSSOP Package	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, Vin and Vout should be constrained to the range GND \leq (V_{in} or V_{out}) \leq V_{CC}.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

†Derating: SOIC Package: -7 mW/°C from 65° to 125°C

TSSOP Package: -6.1 mW/°C from 65° to 125°C





RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Max	Unit
V _{CC}	Positive DC Supply Voltage	(Referenced to GND) (Referenced to V _{EE})	2.0 2.0	6.0 12.0	V
V_{EE}	Negative DC Supply Voltage, Output (Referenced to GND)			GND	V
V _{IS}	Analog Input Voltage		V_{EE}	V _{CC}	V
V _{in}	Digital Input Voltage (Referenced to GND)		GND	V _{CC}	V
V _{IO} *	Static or Dynamic Voltage Across Switch			1.2	V
T _A	Operating Temperature Range, All Package Types		-55	+125	°C
t _r , t _f	Input Rise/Fall Time (Channel Select or Enable Inputs)	V _{CC} = 2.0 V V _{CC} = 3.0 V V _{CC} = 4.5 V V _{CC} = 6.0 V	0 0 0 0	1000 600 500 400	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond

the Recommended Operating Ranges limits may affect device reliability. *For voltage drops across switch greater than 1.2 V (switch on), excessive V_{CC} current may be drawn; i.e., the current out of the switch may contain both V_{CC} and switch input components. The reliability of the device will be unaffected unless the Maximum Ratings are exceeded.

			Vcc	Guaranteed Limit			
Symbol	Parameter	Condition	V	–55 to 25°C	≤85°C	≤125°C	Unit
V _{IH}	Minimum High-Level Input Voltage, Channel-Select or Enable Inputs	R _{on} = Per Spec	2.0 3.0 4.5 6.0	1.50 2.10 3.15 4.20	1.50 2.10 3.15 4.20	1.50 2.10 3.15 4.20	V
VIL	Maximum Low–Level Input Voltage, Channel–Select or Enable Inputs	R _{on} = Per Spec	2.0 3.0 4.5 6.0	0.5 0.9 1.35 1.8	0.5 0.9 1.35 1.8	0.5 0.9 1.35 1.8	V
l _{in}	Maximum Input Leakage Current, Channel-Select or Enable Inputs	$V_{in} = V_{CC}$ or GND, $V_{EE} = -6.0 V$	6.0	± 0.1	± 1.0	± 1.0	μΑ
I _{CC}	Maximum Quiescent Supply Current (per Package)	$ \begin{array}{ll} \mbox{Channel Select, Enable and} \\ \mbox{V}_{IS} = \mbox{V}_{CC} \mbox{ or GND}; & \mbox{V}_{EE} = \mbox{GND} \\ \mbox{V}_{IO} = 0 \ \mbox{V} & \mbox{V}_{EE} = - \mbox{6.0} \end{array} $	6.0 6.0	1 4	10 40	20 80	μΑ

DC CHARACTERISTICS — Digital Section (Voltages Referenced to GND) VEE = GND, Except Where Noted



DC CHARACTERISTICS — Analog Section

					Guara	nteed Lim	nit	
Symbol	Parameter	Condition	Vcc	V _{EE}	–55 to 25°C	≤85°C	≤125°C	Unit
R _{on}	Maximum "ON" Resistance		4.5 4.5 6.0	0.0 - 4.5 - 6.0	190 120 100	240 150 125	280 170 140	Ω
			4.5 4.5 6.0	0.0 - 4.5 - 6.0	150 100 80	190 125 100	230 140 115	
ΔR_{on}	Maximum Difference in "ON" Resistance Between Any Two Channels in the Same Package		4.5 4.5 6.0	0.0 - 4.5 - 6.0	30 12 10	35 15 12	40 18 14	Ω
I _{off}	Maximum Off–Channel Leakage Current, Any One Channel		6.0	- 6.0	0.1	0.5	1.0	μΑ
	Maximum Off–ChannelHC4051A Leakage Current, HC4052A Common Channel HC4053A	$V_{IO} = V_{CC} - V_{EE};$	6.0 6.0 6.0	- 6.0 - 6.0 - 6.0	0.2 0.1 0.1	2.0 1.0 1.0	4.0 2.0 2.0	
I _{on}	Maximum On–ChannelHC4051A Leakage Current, HC4052A Channel–to–Channel HC4053A	Switch-to-Switch =	6.0 6.0 6.0	- 6.0 - 6.0 - 6.0	0.2 0.1 0.1	2.0 1.0 1.0	4.0 2.0 2.0	μΑ

AC CHARACTERISTICS ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

			Vcc	Guaranteed Limit			
Symbol	Parameter		v	–55 to 25°C	≤85°C	≤125°C	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Channel–Select to Ana (Figure 9)	log Output	2.0 3.0 4.5 6.0	270 90 59 45	320 110 79 65	350 125 85 75	ns
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Analog Input to Analog (Figure 10)	Output	2.0 3.0 4.5 6.0	40 25 12 10	60 30 15 13	70 32 18 15	ns
t _{PLZ} , t _{PHZ}	Maximum Propagation Delay, Enable to Analog Outpu (Figure 11)	ut	2.0 3.0 4.5 6.0	160 70 48 39	200 95 63 55	220 110 76 63	ns
t _{PZL} , t _{PZH}	Maximum Propagation Delay, Enable to Analog Outpu (Figure 11)	ut	2.0 3.0 4.5 6.0	245 115 49 39	315 145 69 58	345 155 83 67	ns
C _{in}	Maximum Input Capacitance, Channel-Select or Ena	ble Inputs		10	10	10	pF
C _{I/O}	Maximum Capacitance	Analog I/O		35	35	35	pF
	(All Switches Off) Common	O/I: HC4051A HC4052A HC4053A		130 80 50	130 80 50	130 80 50	
		Feed-through		1.0	1.0	1.0	
			Туріса	I @ 25°C, V _{CC}	= 5.0 V, V	_{EE} = 0 V	
C _{PD}	Power Dissipation Capacitance (Figure 13)*	HC4051A HC4052A HC4053A		45 80 45			pF

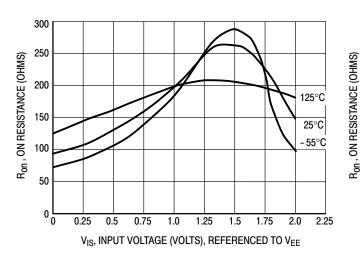
* Used to determine the no–load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

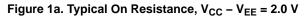


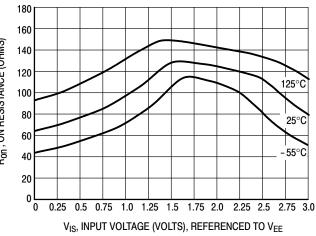
ADDITIONAL APPLICATION CHARACTERISTICS (GND = 0 V)

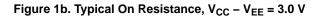
			v _{cc}	V _{EE}	Limit*			
Symbol	Parameter	Condition	V	V		25°C		Unit
BW	Maximum On–Channel Bandwidth or Minimum Frequency Response (Figure 6)	$ f_{in} = 1 MHz Sine Wave; Adjust f_{in} Voltage to Obtain 0dBm at V_{OS}; Increase f_{in} Frequency Until dB Meter Reads –3dB; R_L = 50\Omega, C_L = 10pF $	2.25 4.50 6.00	-2.25 -4.50 -6.00	'51 80 80 80	'52 95 95 95	'53 120 120 120	MHz
-	Off–Channel Feed–through Isolation (Figure 7)	$ \begin{array}{l} f_{in} = \text{Sine Wave; Adjust } f_{in} \text{ Voltage to} \\ \text{Obtain 0dBm at } \text{V}_{\text{IS}} \\ f_{in} = 10 \text{kHz}, \ \text{R}_{L} = 600 \Omega, \ \text{C}_{L} = 50 \text{pF} \end{array} $	2.25 4.50 6.00	-2.25 -4.50 -6.00		-50 -50 -50		dB
		f _{in} = 1.0MHz, R _L = 50Ω, C _L = 10pF	2.25 4.50 6.00	-2.25 -4.50 -6.00		-40 -40 -40		
-	Feedthrough Noise. Channel–Select Input to Common I/O (Figure 8)	$ \begin{array}{l} V_{in} \leq 1 MHz \; Square \; Wave \; (t_r = t_f = 6ns); \\ Adjust \; R_L \; at \; Setup \; so \; that \; I_S = 0A; \\ Enable = GND \qquad R_L = 600 \Omega, \; C_L = 50 pF \end{array} $	2.25 4.50 6.00	-2.25 -4.50 -6.00		25 105 135		mV _{PP}
		$R_L = 10k\Omega, C_L = 10pF$	2.25 4.50 6.00	-2.25 -4.50 -6.00		35 145 190		
-	Crosstalk Between Any Two Switches (Figure 12) (Test does not apply to HC4051A)	$ \begin{aligned} f_{in} &= \text{Sine Wave; Adjust } f_{in} \text{ Voltage to} \\ \text{Obtain 0dBm at } \text{V}_{IS} \\ f_{in} &= 10 \text{kHz}, \text{ R}_L = 600 \Omega, \text{ C}_L = 50 \text{pF} \end{aligned} $	2.25 4.50 6.00	-2.25 -4.50 -6.00		-50 -50 -50		dB
		f _{in} = 1.0MHz, R _L = 50Ω, C _L = 10pF	2.25 4.50 6.00	-2.25 -4.50 -6.00		60 60 60		
THD	Total Harmonic Distortion (Figure 14)	$\label{eq:states} \begin{array}{l} f_{in} = 1 \text{kHz}, \ \text{R}_L = 10 \text{k}\Omega, \ \text{C}_L = 50 \text{pF} \\ \text{THD} = \text{THD}_{measured} - \text{THD}_{source} \\ & V_{IS} = 4.0 \text{V}_{PP} \ \text{sine wave} \\ & V_{IS} = 8.0 \text{V}_{PP} \ \text{sine wave} \\ & V_{IS} = 11.0 \text{V}_{PP} \ \text{sine wave} \end{array}$	2.25 4.50 6.00	-2.25 -4.50 -6.00		0.10 0.08 0.05		%

*Limits not tested. Determined by design and verified by qualification.











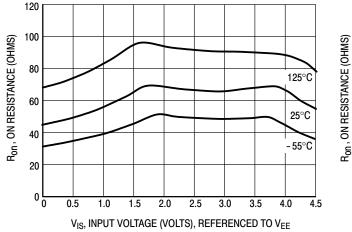


Figure 1c. Typical On Resistance, $V_{CC} - V_{EE} = 4.5 V$

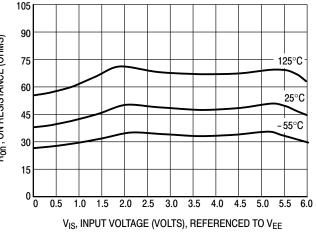


Figure 1d. Typical On Resistance, $V_{CC} - V_{EE} = 6.0 V$

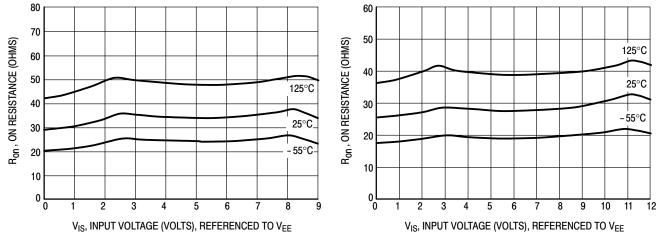


Figure 1e. Typical On Resistance, $V_{CC} - V_{EE} = 9.0 V$

Figure 1f. Typical On Resistance, $V_{CC} - V_{EE} = 12.0 V$

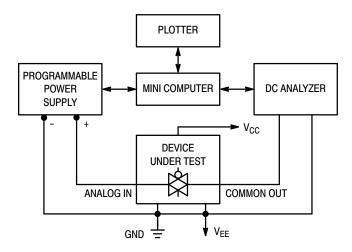


Figure 2. On Resistance Test Set–Up



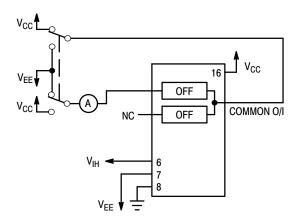
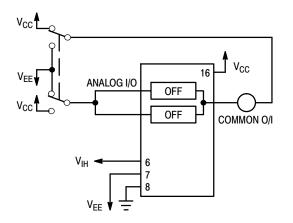
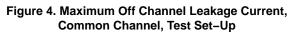


Figure 3. Maximum Off Channel Leakage Current, Any One Channel, Test Set-Up





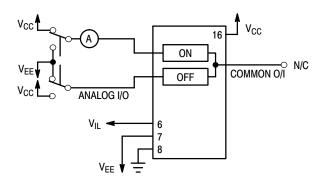
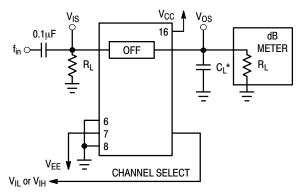


Figure 5. Maximum On Channel Leakage Current, Channel to Channel, Test Set-Up



*Includes all probe and jig capacitance



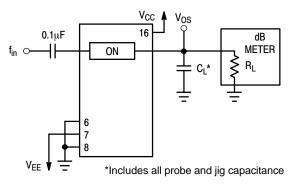
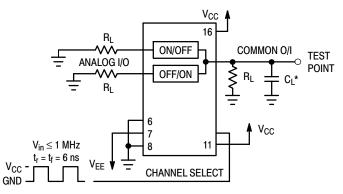


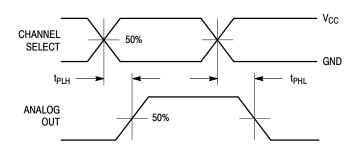
Figure 6. Maximum On Channel Bandwidth, Test Set-Up

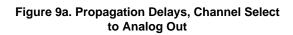


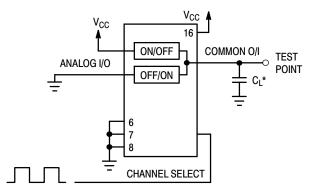
*Includes all probe and jig capacitance

Figure 8. Feedthrough Noise, Channel Select to Common Out, Test Set-Up









*Includes all probe and jig capacitance

Figure 9b. Propagation Delay, Test Set–Up Channel Select to Analog Out

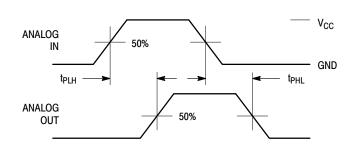
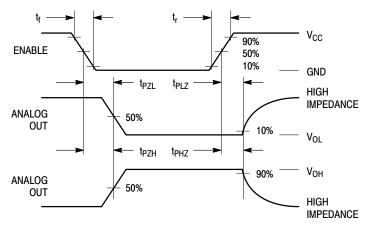
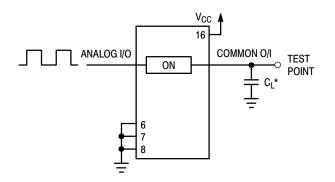


Figure 10a. Propagation Delays, Analog In to Analog Out







*Includes all probe and jig capacitance

Figure 10b. Propagation Delay, Test Set–Up Analog In to Analog Out

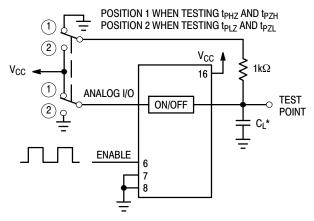
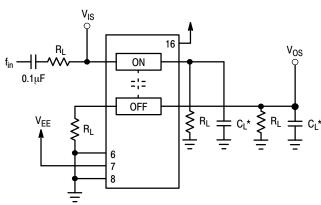


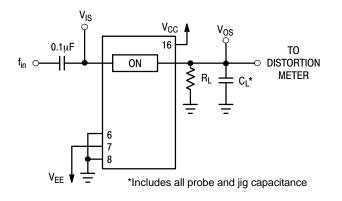
Figure 11b. Propagation Delay, Test Set–Up Enable to Analog Out





*Includes all probe and jig capacitance

Figure 12. Crosstalk Between Any Two Switches, Test Set–Up





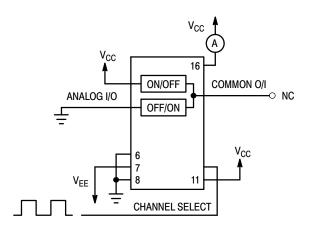


Figure 13. Power Dissipation Capacitance, Test Set–Up

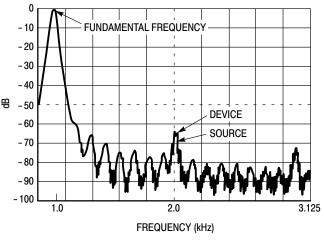


Figure 14b. Plot, Harmonic Distortion

APPLICATIONS INFORMATION

The Channel Select and Enable control pins should be at V_{CC} or GND logic levels. V_{CC} being recognized as a logic high and GND being recognized as a logic low. In this example:

$$V_{CC} = +5V = logic high$$

GND = 0V = logic low

The maximum analog voltage swings are determined by the supply voltages V_{CC} and V_{EE} . The positive peak analog voltage should not exceed V_{CC} . Similarly, the negative peak analog voltage should not go below V_{EE} . In this example, the difference between V_{CC} and V_{EE} is ten volts. Therefore, using the configuration of Figure 15, a maximum analog signal of ten volts peak–to–peak can be controlled. Unused analog inputs/outputs may be left floating (i.e., not connected). However, tying unused analog inputs and outputs to V_{CC} or GND through a low value resistor helps minimize crosstalk and feed-through noise that may be picked up by an unused switch.

Although used here, balanced supplies are not a requirement. The only constraints on the power supplies are that:

$$\begin{split} V_{CC} - GND &= 2 \text{ to } 6 \text{ volts} \\ V_{EE} - GND &= 0 \text{ to } -6 \text{ volts} \\ V_{CC} - V_{EE} &= 2 \text{ to } 12 \text{ volts} \\ \text{ and } V_{EE} &\leq GND \end{split}$$

When voltage transients above V_{CC} and/or below V_{EE} are anticipated on the analog channels, external Germanium or Schottky diodes (D_x) are recommended as shown in Figure 16. These diodes should be able to absorb the maximum anticipated current surges during clipping.



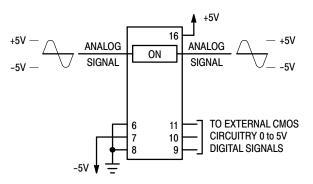


Figure 15. Application Example

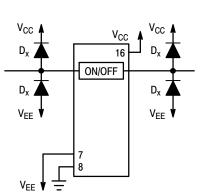
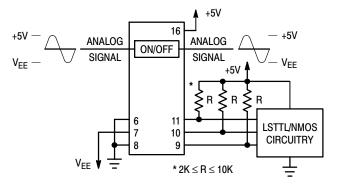
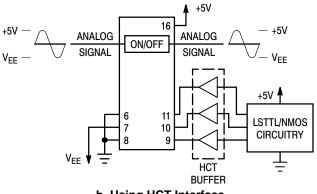


Figure 16. External Germanium or **Schottky Clipping Diodes**

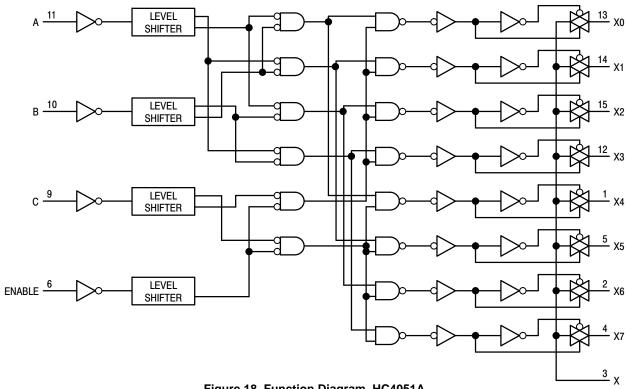


a. Using Pull-Up Resistors



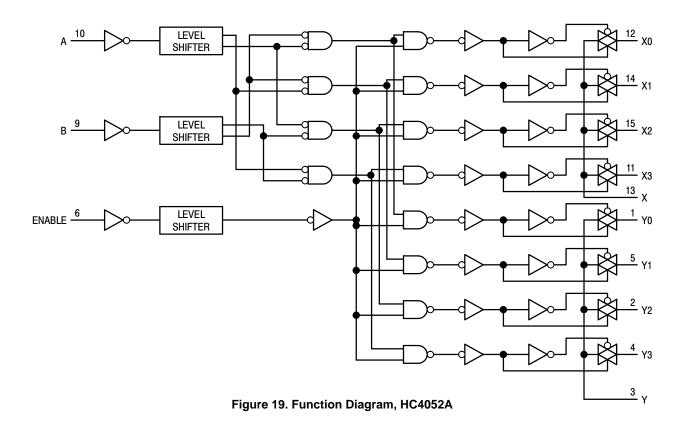
b. Using HCT Interface











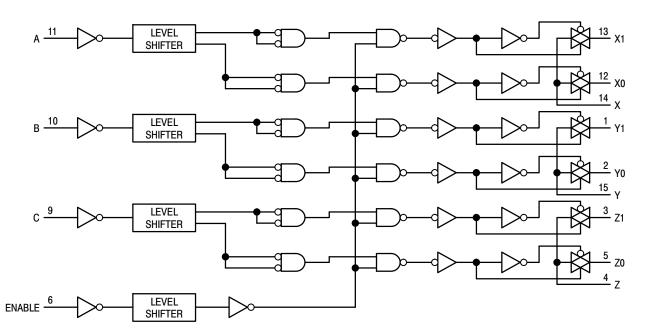


Figure 20. Function Diagram, HC4053A



ORDERING INFORMATION

Device	Package	Shipping [†]		
MC74HC4051ADG	SOIC-16	48 Units / Rail		
MC74HC4051ADR2G	(Pb-Free)	2500 Units / Tape & Reel		
MC74HC4051ADWG	SOIC-16 WIDE	48 Units / Rail		
MC74HC4051ADWR2G	(Pb-Free)	1000 Units / Tape & Reel		
MC74HC4051ADTG	TSSOP-16	96 Units / Rail		
MC74HC4051ADTR2G	(Pb-Free)	2500 Units / Tape & Reel		
NLVHC4051AMNTWG* (In Development)	QFN16 (Pb-Free)	3000 Units / Tape & Reel		
MC74HC4052ADG	SOIC-16	48 Units / Rail		
MC74HC4052ADR2G	(Pb-Free)	2500 Units / Tape & Reel		
MC74HC4052ADWR2G	SOIC-16 WIDE (Pb-Free)	1000 Units / Tape & Reel		
MC74HC4052ADTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel		
NLVHC4052AMNTWG* (In Development)	QFN16 (Pb–Free)	3000 Units / Tape & Reel		
MC74HC4053ADG		48 Units / Rail		
MC74HC4053ADR2G	SOIC–16 (Pb–Free)	2500 Units / Tape & Reel		
NLV74HC4053ADR2G*		2500 Units / Tape & Reel		
MC74HC4053ADWR2G	SOIC-16 WIDE	1000 Units / Tape & Reel		
NLV74HC4053ADWR2G*	(Pb-Free)	1000 Units / Tape & Reel		
MC74HC4053ADTR2G	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel		

DISCONTINUED (Note 1)

NLV74HC4051ADR2G*		2500 Units / Tape & Reel		
MC74HC4051AADR2G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel		
NLV74HC4051AADR2G*		2500 Units / Tape & Reel		
NLVHC4051ADWR2G*	SOIC-16 WIDE (Pb-Free)	1000 Units / Tape & Reel		
NLVHC4051ADTR2G*	TSSOP-16	2500 Units / Tape & Reel		
NLVHC4051AADTR2G*	(Pb-Free)	2500 Units / Tape & Reel		

NLV74HC4052ADR2G*	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel	
MC74HC4052ADWG	SOIC-16 WIDE (Pb-Free)	48 Units / Rail	
MC74HC4052ADTG		96 Units / Rail	
NLV74HC4052ADTRG*	TSSOP–16 (Pb–Free)	2500 Units / Tape & Reel	
NLVHC4052ADTR2G*		2500 Units / Tape & Reel	

MC74HC4053ADWG	SOIC-16 WIDE	48 Units / Rail
NLV74HC4053ADWRG*	(Pb-Free)	1000 Units / Tape & Reel
MC74HC4053ADTG	TSSOP-16	96 Units / Rail
NLVHC4053ADTR2G*	(Pb-Free)	2500 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.

1. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.



MILLIMETERS

NOM

1.55

0.18

1.37

0.42

0.22

9.90 BSC

MIN

1.35

0.10

1.25

0.35

0.19

DIM

А

Α1

A2

b

С

D

SOIC-16 9.90x3.90x1.37 1.27P CASE 751B ISSUE M

DATE 18 OCT 2024

MAX

1.75

0.25

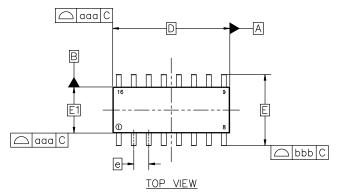
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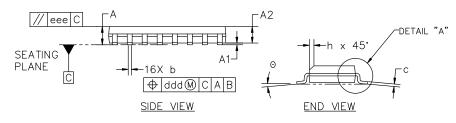
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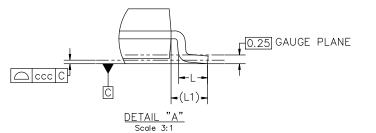
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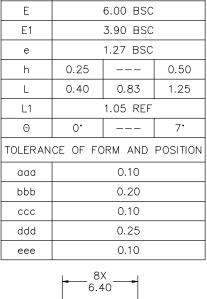
NOTES:

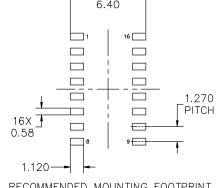
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
- 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE & DIMENSION AT MAXIMUM MATERIAL CONDITION.











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SOIC-16 9.90x3.90x1.37 1.27P CASE 751B ISSUE M

DATE 18 OCT 2024

GENERIC MARKING DIAGRAM*

16	A	H	A.	- A	R	A	A	Æ
		XX)						
		XX	XX	XX	XX	XX)	XX	x
	0				YW			
1	H	Н	Н	Н	Н	Н	H	Т

XXXXX = Specific Device Code

A = Assembly Location

- WL = Wafer Lot
- Y = Year
- WW = Work Week
- G = Pb-Free Package

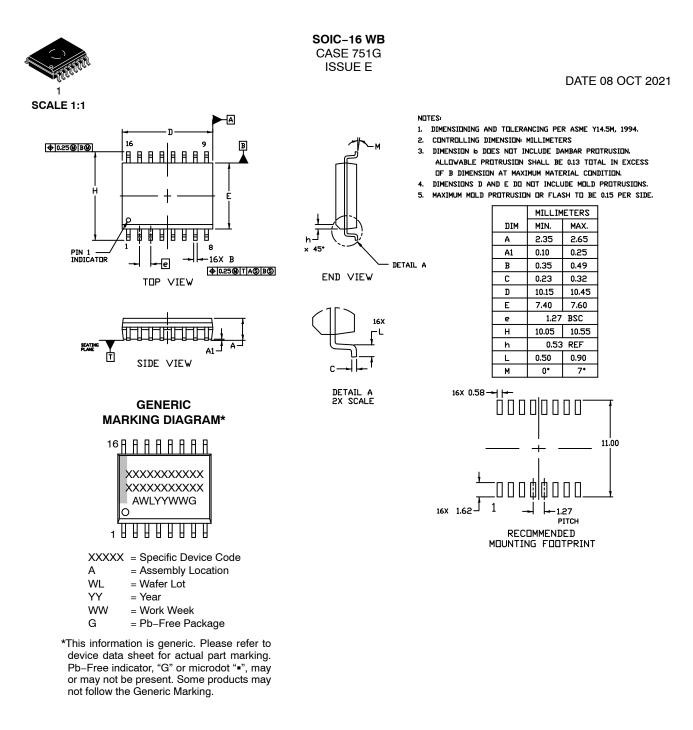
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:	
PIN 1.		PIN 1.		PIN 1.	COLLECTOR, DYE #1	PIN 1.	
2.		2.	ANODE	2.	BASE, #1	2.	
3.	EMITTER	3.	NO CONNECTION	3.	EMITTER, #1	3.	••••
4.	NO CONNECTION	4.	CATHODE	4.	COLLECTOR, #1	4.	
5.		5.	CATHODE	5.	COLLECTOR, #2	5.	COLLECTOR, #3
6.		6.	NO CONNECTION	6.	BASE, #2	6.	COLLECTOR, #3
7.	COLLECTOR	7.	ANODE	7.	EMITTER, #2	7.	COLLECTOR, #4
8.	COLLECTOR	8.	CATHODE	8.	COLLECTOR, #2	8.	COLLECTOR, #4
9.	BASE	9.	CATHODE	9.	COLLECTOR, #3	9.	BASE, #4
10.	EMITTER	10.	ANODE	10.	BASE, #3	10.	EMITTER, #4
11.	NO CONNECTION	11.	NO CONNECTION	11.	EMITTER, #3	11.	BASE, #3
12.	EMITTER	12.	CATHODE	12.	COLLECTOR, #3	12.	EMITTER, #3
13.	BASE	13.	CATHODE	13.	COLLECTOR, #4	13.	BASE, #2
14.	COLLECTOR	14.	NO CONNECTION	14.	BASE, #4	14.	EMITTER, #2
15.	EMITTER	15.	ANODE	15.	EMITTER, #4	15.	BASE, #1
16.	COLLECTOR	16.	CATHODE	16.	COLLECTOR, #4	16.	EMITTER, #1
STVLE 5		STVLE 6		STVLE 7			
STYLE 5: PIN 1	DRAIN DYE #1	STYLE 6: PIN 1	CATHODE	STYLE 7: PIN 1	SOURCE N-CH		
PIN 1.	DRAIN, DYE #1 DRAIN #1	PIN 1.	CATHODE	PIN 1.	SOURCE N-CH	h	
PIN 1. 2.	DRAIN, #1	PIN 1. 2.	CATHODE	PIN 1. 2.	COMMON DRAIN (OUTPUT		
PIN 1. 2. 3.	DRAIN, #1 DRAIN, #2	PIN 1. 2. 3.	CATHODE CATHODE	PIN 1. 2. 3.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT		
PIN 1. 2. 3. 4.	DRAIN, #1 DRAIN, #2 DRAIN, #2	PIN 1. 2. 3. 4.	CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH)	
PIN 1. 2. 3. 4. 5.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3	PIN 1. 2. 3. 4. 5.	CATHODE CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4. 5.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT)	
PIN 1. 2. 3. 4. 5. 6.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3	PIN 1. 2. 3. 4. 5. 6.	CATHODE CATHODE CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4. 5. 6.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT))	
PIN 1. 2. 3. 4. 5. 6. 7.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4	PIN 1. 2. 3. 4. 5. 6. 7.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4. 5. 6. 7.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT))	
PIN 1. 2. 3. 4. 5. 6. 7. 8.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #4 DRAIN, #4	PIN 1. 2. 3. 4. 5. 6. 7. 8.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4. 5. 6. 7. 8.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH))	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 GATE, #4	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH)))	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT)))	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 GATE, #3	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT))))	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10. 11.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 GATE, #3 SOURCE, #3	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT))))	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 11. 12. 13.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 SOURCE, #3 SOURCE, #3 SOURCE, #3	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 11. 12. 13.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE N-CH))))	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13. 14.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 GATE, #3 SOURCE, #2 SOURCE, #2	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13. 14.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE ANODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13. 14.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE N-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT)))))	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 11. 12. 13.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 SOURCE, #3 SOURCE, #3 SOURCE, #3	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10. 11. 12. 13. 13. 14. 15.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 11. 12. 13.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE N-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT)))))	

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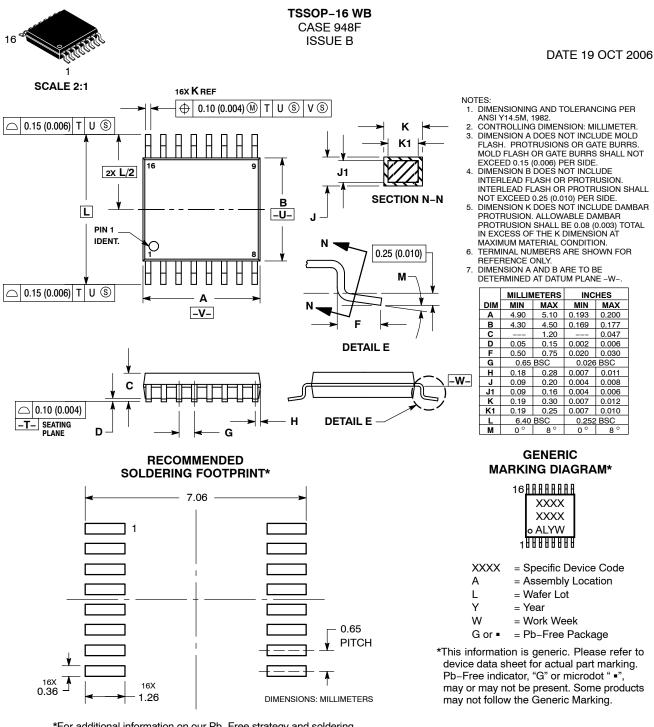
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